

# BTA16, BTB16 T1610, T1635

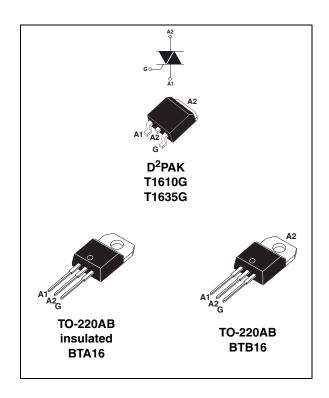
## 16 A Snubberless™, logic level and standard Triacs

#### **Features**

- Medium current Triac
- Low thermal resistance with clip bonding
- Low thermal resistance insulation ceramic for insulated BTA
- High commutation (4Q) or very high commutation (3Q) capability
- BTA series UL1557 certified (File ref: 81734)
- RoHS (2002/95/EC) compliant
- Insulated tab (BTA series, rated at 2500 V<sub>RMS</sub>)

#### **Applications**

- Snubberless versions (BTA/BTB...W and T1635) especially recommended for use on inductive loads, because of their high commutation performances
- On/off or phase angle function in applications such as static relays, light dimmers and appliance motor speed controllers



## **Description**

Available either in through-hole or surface-mount packages, the BTA16, BTB16, T1610 and T1635 Triacs series are suitable for general purpose mains power AC switching.

Table 1. Device summary

Symbol	Parameter	BTA16 <sup>(1)</sup>	BTB16	T1610	T1635
I <sub>T(RMS)</sub>	On-state rms current	16	16	16	16
V <sub>DRM</sub> /V <sub>RRM</sub>	Repetitive peak off-state voltage	600/800	600/800	600/800	600/800
I <sub>GT</sub> (Snubberless)	Triggering gate current	35/50	35/50	-	35
I <sub>GT</sub> (logic level)	ogic level) Triggering gate current		10	10	-
I <sub>GT</sub> (standard)	Triggering gate current	25/50	25/50	-	-

<sup>1.</sup> Insulated

TM: Snubberless is a trademark of STMicroelectronics

March 2010 Doc ID 7471 Rev 9 1/10

### 1 Characteristics

Table 2. Absolute maximum ratings

Symbol	Paramete		Value	Unit		
I	On-state rms current	D <sup>2</sup> PAK / TO-220AB	T <sub>c</sub> = 100 °C	16	А	
I <sub>T(RMS)</sub>	(full sine wave)	TO-220AB insulated	T <sub>c</sub> = 86 °C	10	A	
	Non repetitive surge peak on-state	F = 50 Hz	t = 20 ms	160		
I <sub>TSM</sub>	current (full cycle, T <sub>j</sub> initial = 25 °C)		t = 16.7 ms	168	Α	
l²t	I <sup>2</sup> t value for fusing	t <sub>p</sub> = 10 ms		144	$A^2s$	
dl/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$ , $t_r \le 100 \text{ ns}$	F = 120 Hz T <sub>j</sub> = 125 °C		50	A/µs	
V <sub>DSM</sub> / V <sub>RSM</sub>	Non repetitive surge peak off-state voltage	t <sub>p</sub> = 10 ms	T <sub>j</sub> = 25 °C	V <sub>DRM</sub> /V <sub>RRM</sub> + 100	V	
I <sub>GM</sub>	Peak gate current	t <sub>p</sub> = 20 μs	T <sub>j</sub> = 125 °C	4	Α	
P <sub>G(AV)</sub>	Average gate power dissipation	1	W			
T <sub>stg</sub>	Storage temperature range	-40 to + 150				
T <sub>j</sub>	Maximum operating junction temperat	-40 to + 125				

Table 3. Electrical characteristics ( $T_j$  = 25 °C, unless otherwise specified) Snubberless and logic level (3 quadrants)

Symbol	Test conditions Quadrant T1610 T1			BTA16 / BTB16			Unit		
Syllibol	rest conditions	Quadrant		11010	11033	sw	cw	BW	Oiiit
I <sub>GT</sub> <sup>(1)</sup>	V <sub>D</sub> = 12 V	I - II - III	Max.	10	35	10	35	50	mA
V <sub>GT</sub>	$R_L = 33 \Omega$	1 - 11 - 111	Max.			1.3			V
V <sub>GD</sub>	$V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$ $T_j = 125 \text{ °C}$	1 - 11 - 111	Min.			0.2			V
I <sub>H</sub> <sup>(2)</sup>	I <sub>T</sub> = 500 mA		Max.	15	35	15	35	50	mA
Iı	I <sub>G</sub> = 1.2 I <sub>GT</sub>	1 - 111	Max.	25	50	25	50	70	mA
"L	IG - 1.2 IGT	II	iviax.	30	60	30	60	80	ША
dV/dt (2)	$V_D = 67 \% V_{DRM}$ gate open	T <sub>j</sub> = 125 °C	Min.	40	500	40	500	1000	V/µs
	$(dV/dt)c = 0.1 V/\mu s$	T <sub>j</sub> = 125 °C		8.5	-	8.5	-	-	
(dl/dt)c (2)	(dV/dt)c = 10 V/μs	T <sub>j</sub> = 125 °C	Min.	3.0	-	3.0	-	-	A/ms
	Without snubber	T <sub>j</sub> = 125 °C		-	8.5	-	8.5	14	

<sup>1.</sup> Minimum IGT is guaranted at 5% of  $\rm I_{GT}$   $\rm max$ 

57

2/10 Doc ID 7471 Rev 9

<sup>2.</sup> For both polarities of A2 referenced to A1

Table 4. Electrical characteristics ( $T_j$  = 25 °C, unless otherwise specified) standard (4 quadrants)

Symbol	rmbol Test conditions			BTA16 / BTB16		Unit
Symbol	rest conditions	Quadrant		С	В	Offic
I <sub>GT</sub> <sup>(1)</sup>	$V_D = 12 V$ $R_L = 33 \Omega$	I - II - III IV	Max.	25 50	50 100	mA
V <sub>GT</sub>		ALL	Max.	1.3		V
$V_{GD}$	$V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$ $T_j = 125 \text{ °C}$	ALL	Min.	0.2		٧
I <sub>H</sub> <sup>(2)</sup>	I <sub>T</sub> = 500 mA		Max.	25	50	mA
	1 121.	I - III - IV	Max.	40	60	mA
'L	$I_L$ $I_G = 1.2 I_{GT}$	II	iviax.	80	120	IIIA
dV/dt (2)	V <sub>D</sub> = 67 %V <sub>DRM</sub> gate open	T <sub>j</sub> = 125 °C	Min.	200	400	V/µs
(dV/dt)c (2)	(dl/dt)c = 7 A/ms	T <sub>j</sub> = 125 °C	Min.	5	10	V/µs

- 1. Minimum IGT is guaranted at 5% of  $\rm I_{GT}$   $\rm max$
- 2. For both polarities of A2 referenced to A1

Table 5. Static characteristics

Symbol	Test conditio	Value	Unit		
V <sub>T</sub> (2)	$I_{TM} = 22.5 \text{ A}$ $t_p = 380  \mu\text{s}$	T <sub>j</sub> = 25 °C	Max.	1.55	V
V <sub>to</sub> (2)	Threshold voltage	T <sub>j</sub> = 125 °C	Max.	0.85	V
R <sub>d</sub> (2)	Dynamic resistance	T <sub>j</sub> = 125 °C	Max.	25	mΩ
I <sub>DRM</sub>	V - V	T <sub>j</sub> = 25 °C	Max.	5	μΑ
I <sub>RRM</sub>	$V_{DRM} = V_{RRM}$	T <sub>j</sub> = 125 °C	iviax.	2	mA

Table 6. Thermal resistance

Symbol		Value	Unit		
В	lunction to coop (AC)		D <sup>2</sup> PAK / TO-220AB	1.2	°C/W
R <sub>th(j-c)</sub>	Junction to case (AC)		TO-220AB insulated	2.1	C/VV
	$S^{(1)} = 1 \text{ cm}^2$		D <sup>2</sup> PAK	45	
R <sub>th(j-a)</sub>	Junction to ambient		TO-220AB / TO-220AB insulated	60	°C/W

1. S = Copper surface under tab

Figure 1. Maximum power dissipation versus Figure 2. On-state rms current versus case on-state rms current (full cycle) temperature (full cycle)

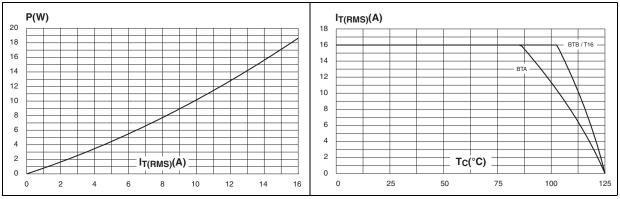


Figure 3. On-state rms current versus ambient temperature (full cycle)

Figure 4. **Relative variation of thermal** impedance versus pulse duration

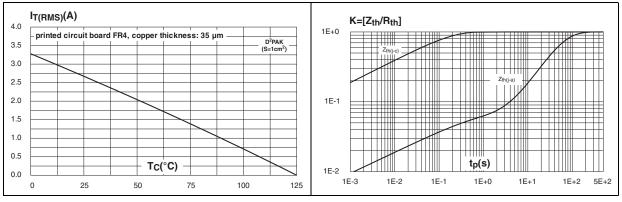
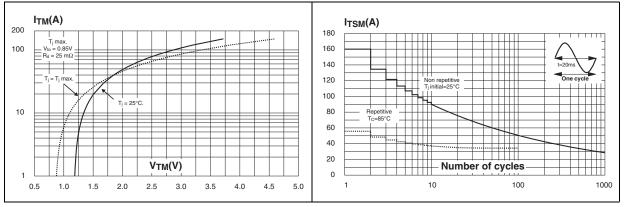


Figure 5. **On-state characteristics** (maximum values)

Figure 6. Surge peak on-state current versus number of cycles



4/10 Doc ID 7471 Rev 9

Figure 7. Non-repetitive surge peak on-state Figure 8. Relative variation of gate trigger current for a sinusoidal current

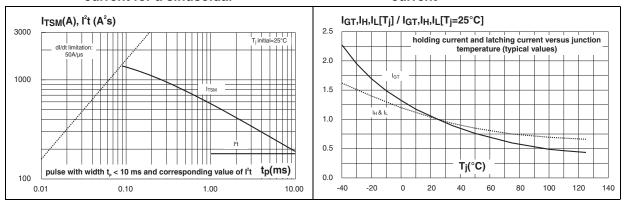


Figure 9. Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values)

Figure 10. Relative variation of critical rate of decrease of main current versus (dV/dt)c (typical values)

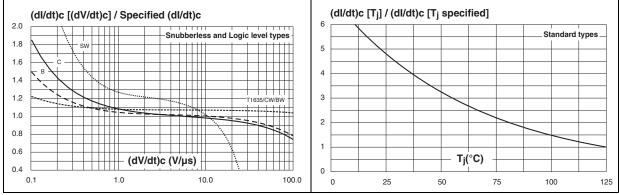
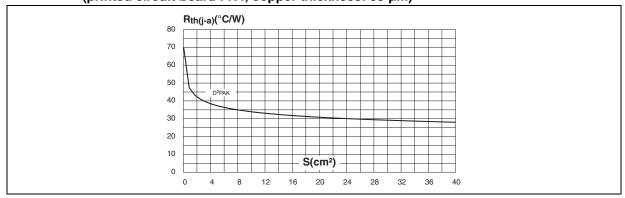


Figure 11. D<sup>2</sup>PAK thermal resistance junction to ambient versus copper surface under tab (printed circuit board FR4, copper thickness: 35 µm)



# 2 Ordering information

Figure 12. Ordering information scheme (BTA16 and BTB16 series)

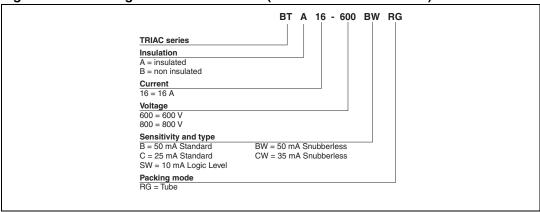


Figure 13. Ordering information scheme (T16 series)

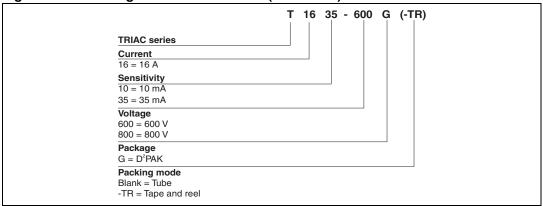


Table 7. Product selector

Device <sup>(1)</sup>	Voltage (xxx)		Sensitivity	Туре	Package	
Device	600 V 800 V		Туре	1 ackage		
BTA/BTB16-xxxB	Х	Х	50 mA	Standard	TO-220AB	
BTA/BTB16-xxxBW	Х	Х	50 mA	Snubberless	TO-220AB	
BTA/BTB16-xxxC	Х		25 mA	Standard	TO-220AB	
BTA/BTB16-xxxCW	Х	Х	35 mA	Snubberless	TO-220AB	
BTA/BTB16-xxxSW	Х	Х	10 mA	Logic level	TO-220AB	
T1610-xxxG	Х	Х	10 mA	Logic level	D <sup>2</sup> PAK	
T1635-xxxG	Х	Х	35 mA	Snubberless	D <sup>2</sup> PAK	

<sup>1.</sup> BTB: non insulated TO-220AB package

6/10 Doc ID 7471 Rev 9

### 3 Package information

- Epoxy meets UL94, V0
- Recommended torque value: 0.4 to 0.6 N⋅m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Table 8. D<sup>2</sup>PAK dimensions

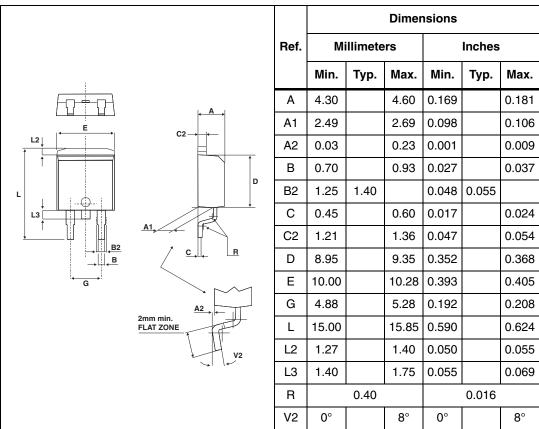
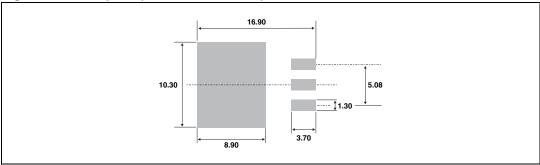


Figure 14. Footprint (dimensions in mm)



577

**Dimensions** Ref. Millimeters Inches Min. Typ. Max. Min. Тур. Max. 15.20 15.90 0.598 0.625 0.147 a1 3.75 В С Ø١ 13.00 14.00 0.511 0.551 a2 В 10.00 10.40 0.393 0.409 L b1 0.61 0.88 0.024 0.034 0.051 b2 1.23 1.32 0.048 С 4.40 4.60 0.173 0.181 13 с1 0.49 0.70 0.019 0.027 c2 2.40 2.72 0.094 0.107 c2 12 a2 2.40 2.70 0.094 0.106 е F 6.20 6.60 0.244 0.259 ØΙ 3.75 3.85 0.147 0.151 0.661 14 15.80 16.40 16.80 0.622 0.646 L 2.65 2.95 0.104 0.116 12 1.14 0.044 0.066 1.70 13 1.14 1.70 0.044 0.066 М 2.60 0.102

Table 9. TO-220AB (non-insulated and insulated) dimensions



# 4 Ordering information

Table 10. Ordering information

Order code <sup>(1)</sup>	Marking <sup>(1)</sup>	Package	Weight	Base qty	Delivery mode
BTA16-xxxyzRG	BTA16xxxyz	TO-220AB	2.3 g	50	Tube
BTB16-xxxyzRG	BTB16xxxyz	TO-220AB	2.3 g	50	Tube
T1610-xxxG-TR	T1610xxxG			1000	Tape and reel
T1635-xxxG	T1635xxxG	D <sup>2</sup> PAK	1.5 g	50	Tube
T1635-xxxG-TR	T1635xxxG			1000	Tape and reel

<sup>1.</sup> xxx = voltage, y = sensitivity, z = type

# 5 Revision history

Table 11. Document revision history

Date	Revision	Changes		
Oct-2002	6A	Last update.		
13-Feb-2006	7	TO-220AB delivery mode changed from bulk to tube. ECOPACK statement added.		
03-Jul-2009	8	Added part number T1610.		
11-Mar-2010	9	Updated value for $V_{DSM}/V_{RSM}$ in <i>Table 2</i> . Updated temperature in <i>Table 2</i> from 15 °C to 86 °C.		

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10/10 Doc ID 7471 Rev 9

